

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : Akihiko ENDO et al. **Mail Stop PCT**
Appl. No. : Not Yet Assigned (U.S. National Phase of PCT/JP2004/013067)
I. A. Filed : September 8, 2004
For : **BONDED WAFER AND ITS MANUFACTURING METHOD**


CLAIM OF PRIORITY

Commissioner for Patents
U.S. Patent and Trademark Office
Customer Service Window, Mail Stop PCT
Randolph Building
401 Dulany Street
Alexandria, VA 22314

Sir:

Applicant hereby claims the right of priority granted pursuant to 35 U.S.C. 119 and 365 based upon Japanese Application No. 2003-315986, filed September 8, 2003. The International Bureau already should have sent a certified copy of the Japanese application to the United States designated office. If the certified copy has not arrived, please contact the undersigned.

Respectfully submitted,
Akihiko ENDO et al.


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March 6, 2006
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